

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Christopher J. de Simone, Lucian M. Hand, Gi Jeong Kim, Seung Mo Kim, Jin An Lee

Assignee: Amkor and ANAM (Jointly)

Title: Nonexposed Heat Sink For Semiconductor Package

Serial No.: 09/513,067 Filing Date: February 24, 2000

Examiner: Chuong A. Luu Group Art Unit: 2825

Docket No.: AB-928 US

San Jose, California
July 26, 2001

COMMISSIONER FOR PATENTS
Washington, D. C. 20231

INFORMATION DISCLOSURE STATEMENT
UNDER CFR § 1.97(c) WITH FEE

Dear Sir:

Pursuant to 37 C.F.R. § 1.56, § 1.97 and § 1.98, Applicant(s) wish to call the following documents (copies enclosed) to the attention of the Examiner.

A PTO form 1449 listing these documents is enclosed.

Citation of the above documents shall not be construed as:

1. an admission that the documents are necessarily prior art with respect to the instant invention;
2. a representation that a search has been made, or
3. an admission that the information cited herein is, or is considered to be, material to patentability as defined in § 1.56(b).

Please charge Deposit Account No. 19-2386 \$180.00 for the Information Disclosure Statement fee under 37 C.F.R. § 1.17(p). The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account 19-2386. This paper is being submitted in duplicate.

EXPRESS MAIL LABEL NO:

EL 701 023 687 US

Respectfully submitted,

James E. Parsons
Attorney for Applicant(s)
Reg. No. 34,691

LAW OFFICES OF
SKJERVEN MORRILL
MacPHERSON LLP

25 METRO DRIVE
SUITE 700
SAN JOSE, CA 95110
(408) 453-9200
FAX (408) 453-7979

08/06/2001 HNDOR1

00000002 192386 09513067

01 FC:126

180.00 CH

781062 vl

-1-

Serial No. 09/513,067

#7 ADS
8/16/01
V. Vannal

RECEIVED
AUG - 5 2001
TC 2800 MAIL ROOM